

Composite Materials with Immobilized AgNPs: A Sustainable Approach to Combat AMR

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Abstract:

Composite materials offer a promising route for advanced biomaterials, enabling tailored composition and surface properties. Silver nanoparticles (AgNPs) provide strong antimicrobial activity but raise toxicity concerns. Anchoring AgNPs onto solid, ideally polymer, pre-treated substrates via covalent bonding preserves their nanoscale size (≤ 50 nm) while improving safety and stability. We present a variety of composite materials, on the fundamental bases of substrate@AgNPs with high antimicrobial efficacy and controlled nanoparticle release, applicable in medical (implant protection, biofilm prevention) and environmental contexts (biofouling-resistant surfaces). This approach supports global efforts to combat antimicrobial resistance—a crisis responsible for 1.27 million deaths annually and projected to reach 10 million by 2050 (WHO).

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